

AP70U02GH

Preliminary

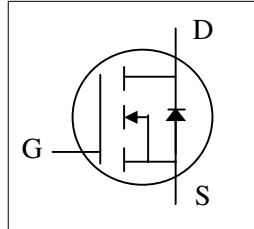


**Advanced Power
Electronics Corp.**

N-CHANNEL ENHANCEMENT MODE

POWER MOSFET

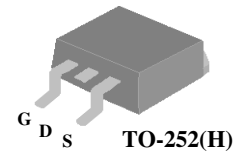
- ▼ Simple Drive Requirement
- ▼ Low On-resistance
- ▼ Fast Switching Characteristic
- ▼ RoHS Compliant



BV_{DSS}	25V
$R_{DS(ON)}$	9m Ω
I_D	60A

Description

The Advanced Power MOSFETs from APEC provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.



The TO-252 package is universally preferred for all commercial-industrial surface mount applications and suited for low voltage applications such as DC/DC converters.

Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	25	V
V_{GS}	Gate-Source Voltage	± 20	V
$I_D@T_C=25^\circ C$	Continuous Drain Current, V_{GS} @ 10V	60	A
$I_D@T_C=100^\circ C$	Continuous Drain Current, V_{GS} @ 10V	41	A
I_{DM}	Pulsed Drain Current ¹	220	A
$P_D@T_C=25^\circ C$	Total Power Dissipation	47	W
	Linear Derating Factor	0.31	W/ $^\circ C$
T_{STG}	Storage Temperature Range	-55 to 175	$^\circ C$
T_J	Operating Junction Temperature Range	-55 to 175	$^\circ C$

Thermal Data

Symbol			Value	Units
Rthj-c	Thermal Resistance Junction-case	Max.	3.2	$^\circ C/W$
Rthj-a	Thermal Resistance Junction-ambient	Max.	110	$^\circ C/W$



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Electrical Characteristics@T_j=25°C(unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	25	-	-	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance ²	$V_{GS}=10V, I_D=40A$	-	-	9	mΩ
		$V_{GS}=4.5V, I_D=30A$	-	-	15	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	1	-	3	V
g_{fs}	Forward Transconductance	$V_{DS}=10V, I_D=40A$	-	39	-	S
I_{DSS}	Drain-Source Leakage Current	$V_{DS}=25V, V_{GS}=0V$	-	-	1	uA
I_{GSS}	Gate-Source Leakage	$V_{GS}= \pm 20V$	-	-	±100	nA
Q_g	Total Gate Charge ²	$I_D=40A$	-	18.5	30	nC
Q_{gs}	Gate-Source Charge	$V_{DS}=20V$	-	3.7	-	nC
Q_{gd}	Gate-Drain ("Miller") Charge	$V_{GS}=4.5V$	-	12.1	-	nC
$t_{d(on)}$	Turn-on Delay Time ²	$V_{DS}=15V$	-	8.3	-	ns
t_r	Rise Time	$I_D=40A$	-	102	-	ns
$t_{d(off)}$	Turn-off Delay Time	$R_G=3.3\Omega, V_{GS}=10V$	-	24	-	ns
t_f	Fall Time	$R_D=0.375\Omega$	-	12	-	ns
C_{iss}	Input Capacitance	$V_{GS}=0V$	-	1360	2180	pF
C_{oss}	Output Capacitance	$V_{DS}=25V$	-	202	-	pF
C_{riss}	Reverse Transfer Capacitance	$f=1.0MHz$	-	198	-	pF

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_{SD}	Forward On Voltage ²	$I_S=30A, V_{GS}=0V$	-	-	1.2	V
t_{rr}	Reverse Recovery Time ²	$I_S=20A, V_{GS}=0V,$	-	30	-	ns
Q_{rr}	Reverse Recovery Charge	$di/dt=100A/\mu s$	-	25	-	nC

Notes:

- 1.Pulse width limited by max. junction temperature.
- 2.Pulse test

THIS PRODUCT IS AN ELECTROSTATIC SENSITIVE, PLEASE HANDLE WITH CAUTION.

THIS PRODUCT HAS BEEN QUALIFIED FOR CONSUMER MARKET. APPLICATIONS OR USES AS CRITERIAL COMPONENT IN LIFE SUPPORT DEVICE OR SYSTEM ARE NOT AUTHORIZED.

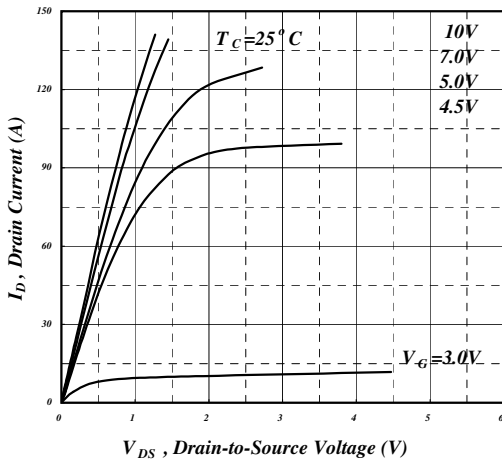


Fig 1. Typical Output Characteristics

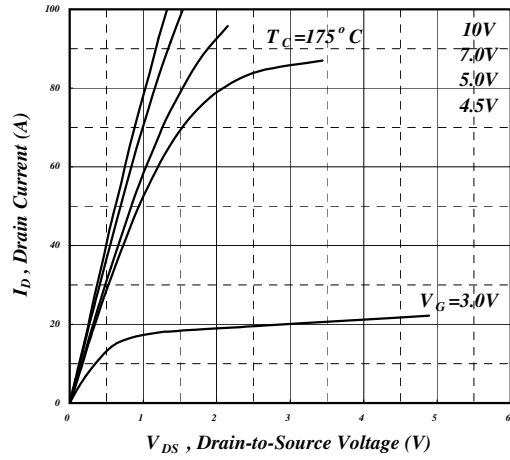


Fig 2. Typical Output Characteristics

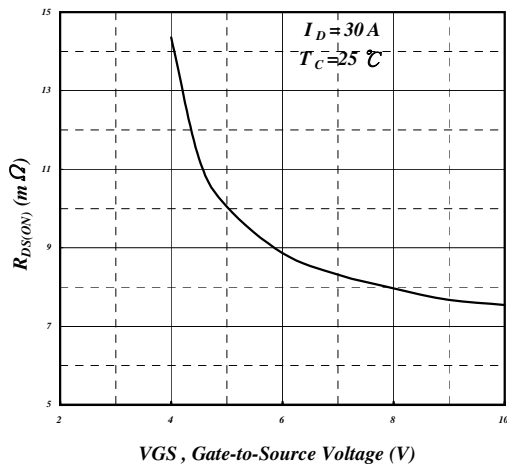


Fig 3. On-Resistance v.s. Gate Voltage

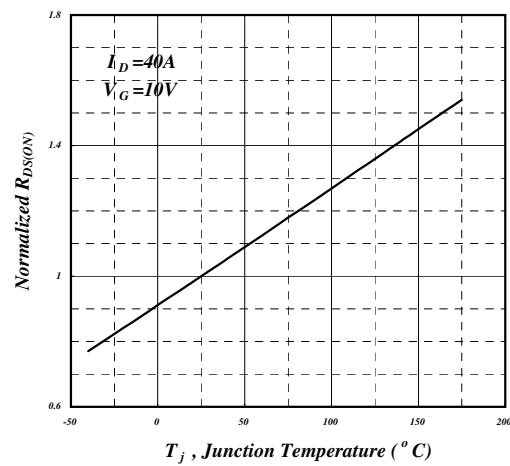


Fig 4. Normalized On-Resistance v.s. Junction Temperature

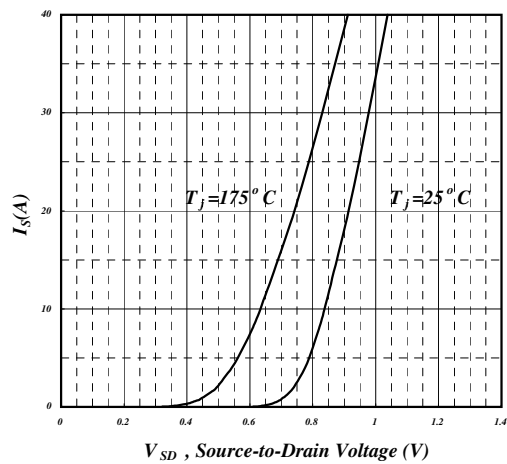


Fig 5. Forward Characteristic of Reverse Diode

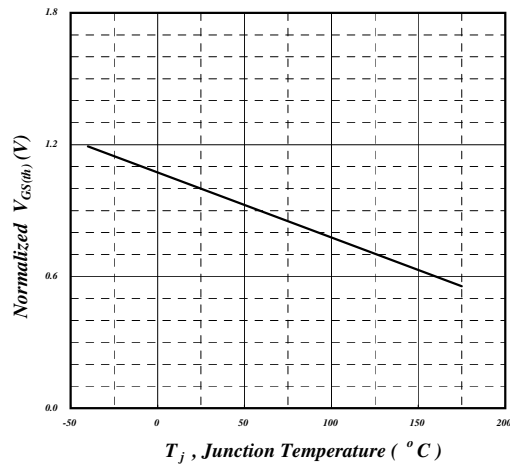


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

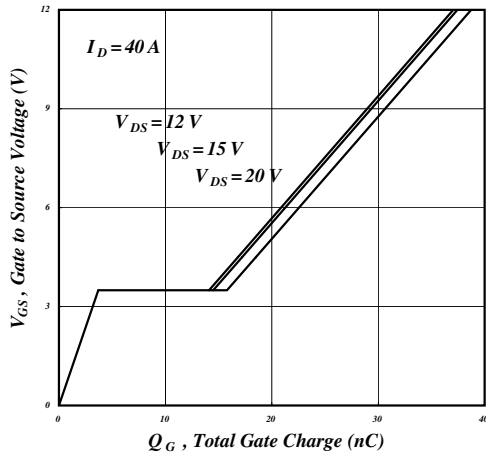


Fig 7. Gate Charge Characteristics

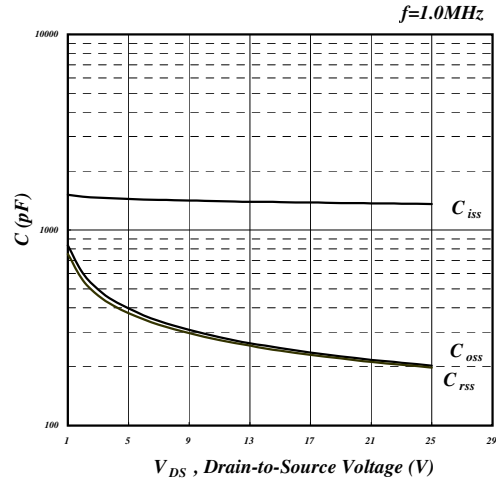


Fig 8. Typical Capacitance Characteristics

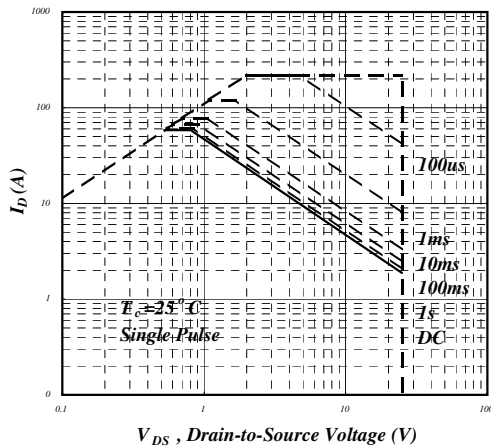


Fig 9. Maximum Safe Operating Area

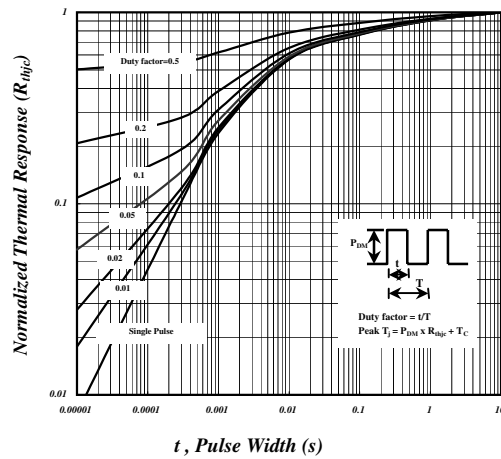


Fig 10. Effective Transient Thermal Impedance

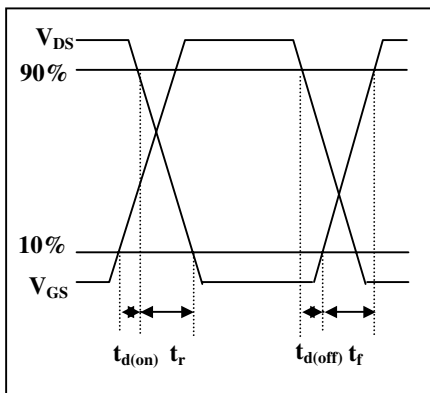


Fig 11. Switching Time Waveform

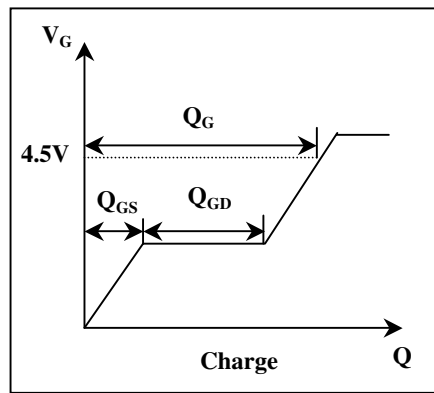
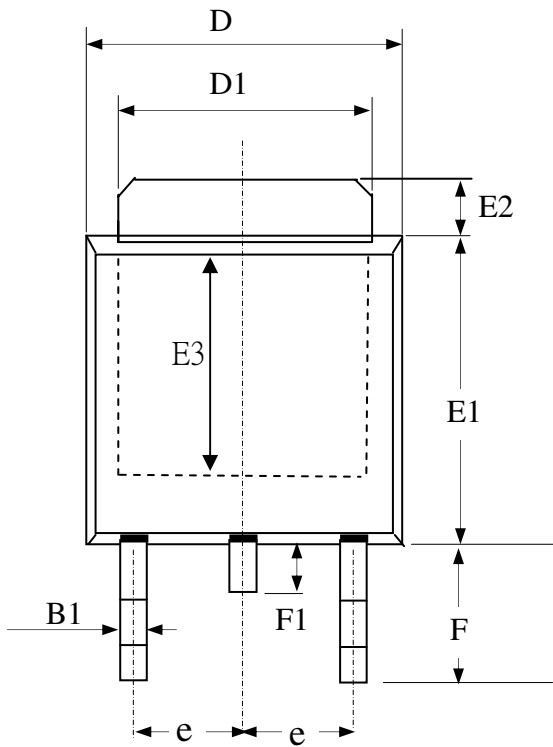


Fig 12. Gate Charge Waveform

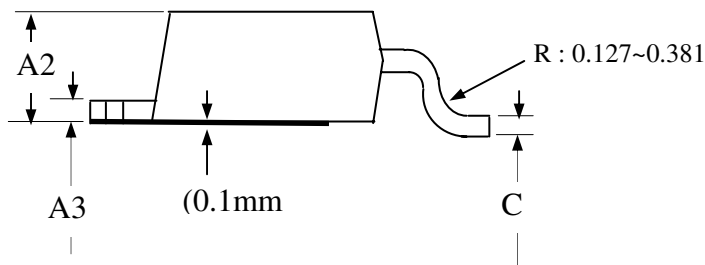


Package Outline : TO-252

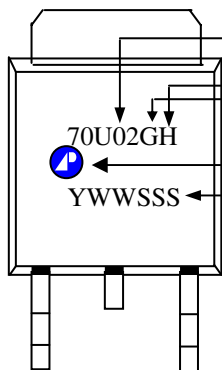


SYMBOLS	Millimeters		
	MIN	NOM	MAX
A2	1.80	2.30	2.80
A3	0.40	0.50	0.60
B1	0.40	0.70	1.00
D	6.00	6.50	7.00
D1	4.80	5.35	5.90
E3	3.50	4.00	4.50
F	2.20	2.63	3.05
F1	0.5	0.85	1.20
E1	5.10	5.70	6.30
E2	0.50	1.10	1.80
e	--	2.30	--
C	0.35	0.50	0.65

- 1.All Dimensions Are in Millimeters.
- 2.Dimension Does Not Include Mold Protrusions.



Part Marking Information & Packing : TO-252



Part Number
 Package Code
 meet Rohs requirement
 LOGO
 Date Code (YWWSSS)
 Y : Last Digit Of The Year
 WW : Week
 SSS : Sequence